

# SHINDENGEN

## General Purpose Rectifiers

SIL Bridges

**D10XB20H**

**200V 10A**

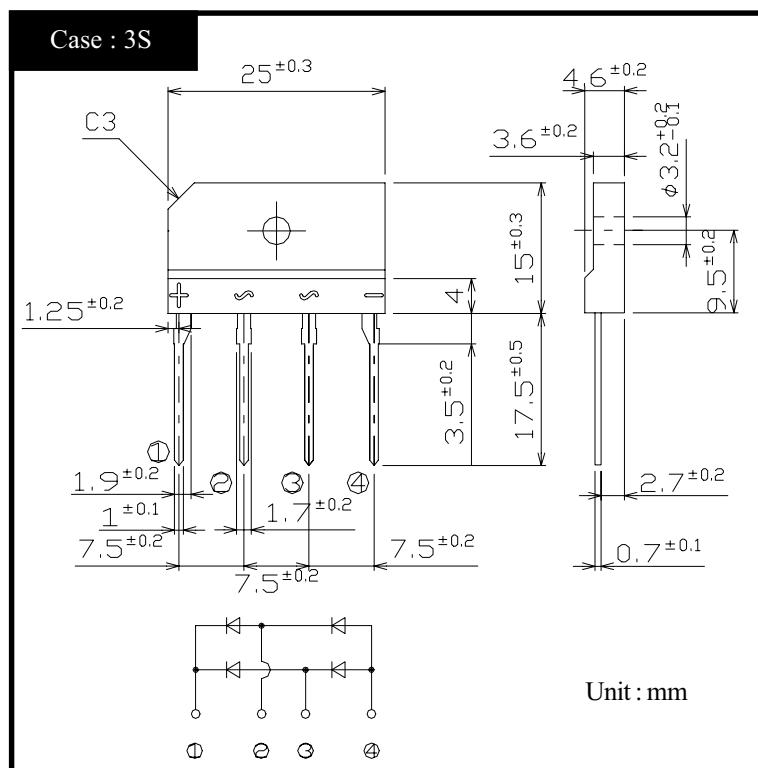
### FEATURES

- Thin Single In-Line Package
- High current capacity with Small Package
- High IFSM
- Superior Thermal Conductivity

### APPLICATION

- Switching power supply
- Home Appliances, Office Equipment
- Factory Automation, Inverter

### OUTLINE DIMENSIONS



### RATINGS

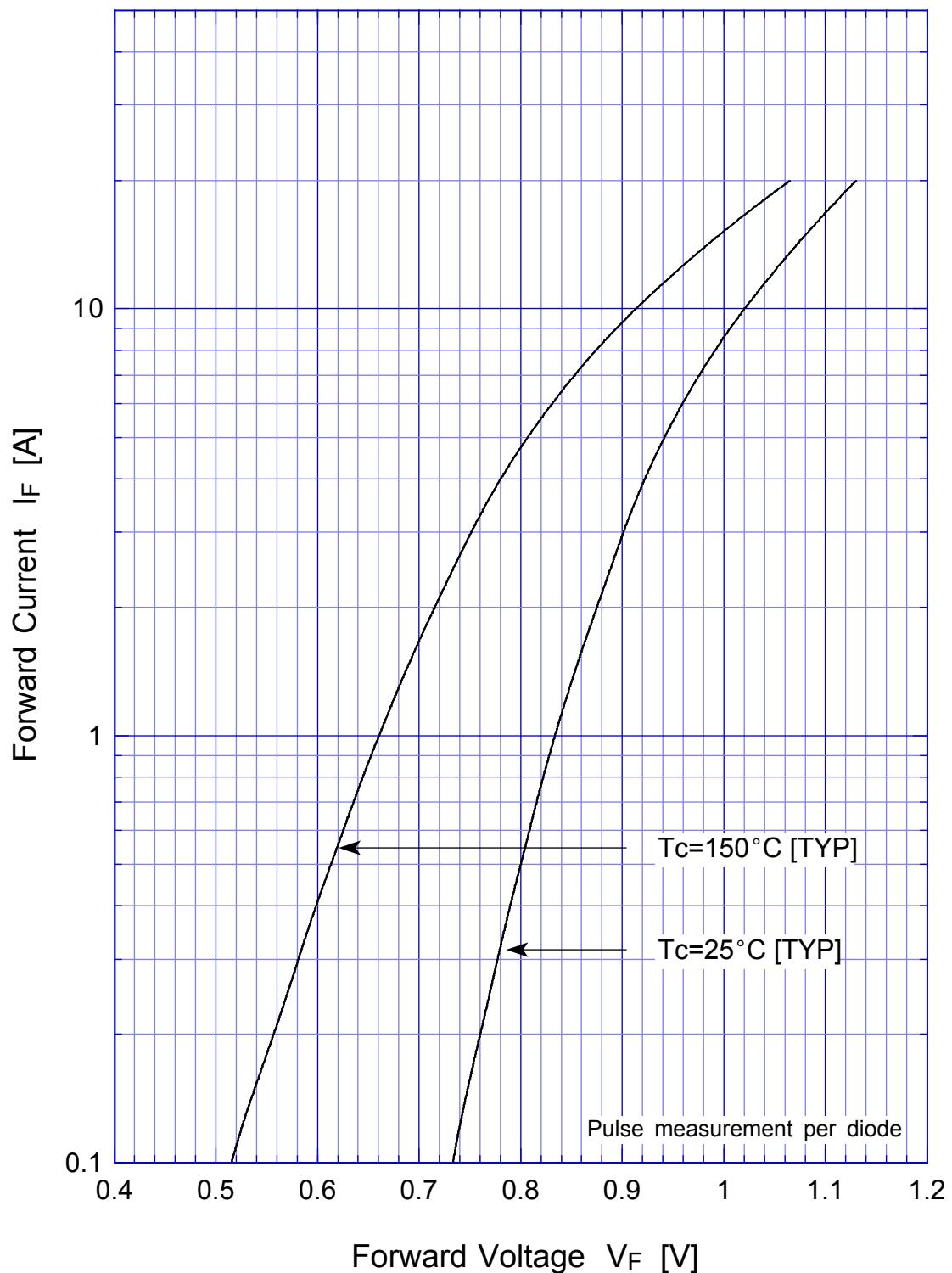
#### ● Absolute Maximum Ratings (If not specified Tc=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage Temperature	Tstg		-40~150	°C
Operating Junction Temperature	Tj		150	°C
Maximum Reverse Voltage	V <sub>RM</sub>		200	V
Average Rectified Forward Current	I <sub>O</sub>	50Hz sine wave, R-load With heatsink Tc=112°C	10	A
		50Hz sine wave, R-load Without heatsink Ta=25°C	2.9	
Peak Surge Forward Current	I <sub>FSM</sub>	50Hz sine wave, Non-repetitive 1cycle peak value, Tj=25°C	170	A
Current Squared Time	I <sup>2</sup> t	1ms≤t<10ms Tj=25°C	110	A <sup>2</sup> s
Dielectric Strength	V <sub>dis</sub>	Terminals to case, AC 1 minute	2.5	kV
Mounting Torque	T <sub>OR</sub>	(Recommended torque:0.5N·m)	0.8	N·m

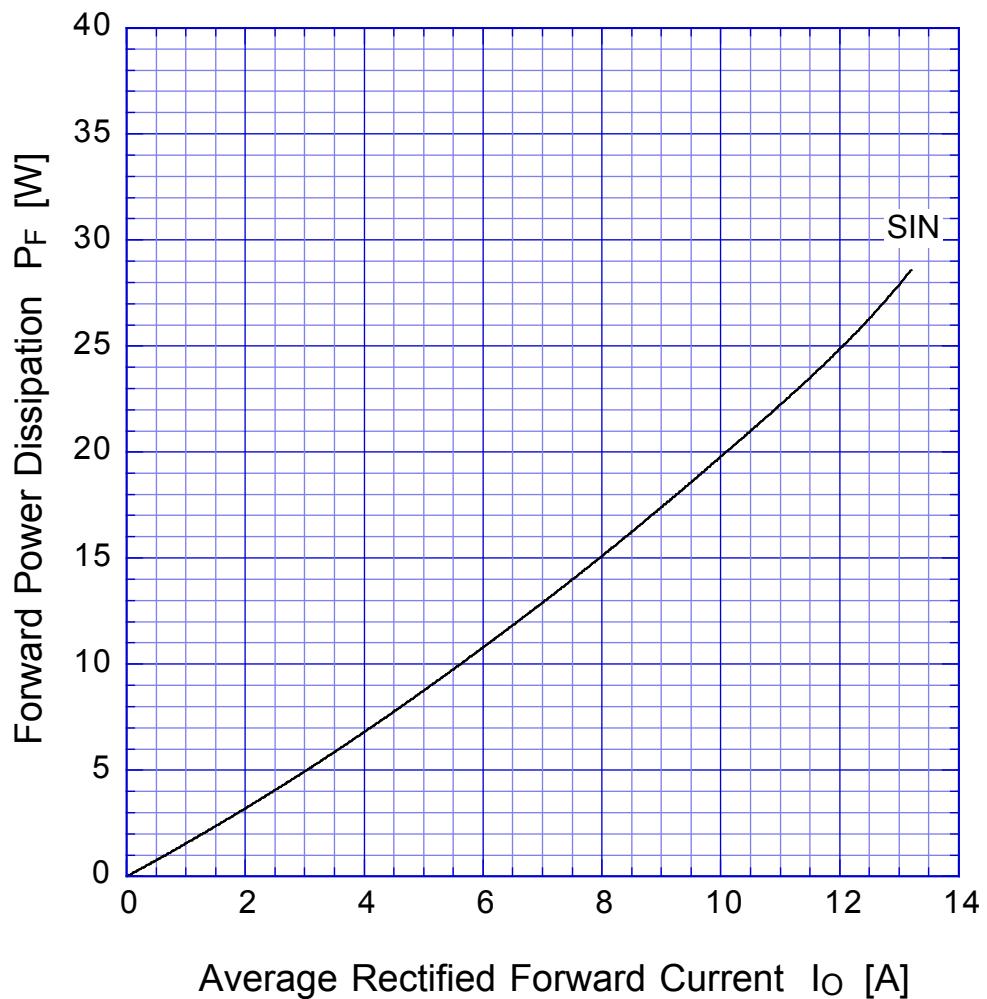
#### ● Electrical Characteristics (If not specified Tc=25°C)

Item	Symbol	Conditions	Ratings	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =5A, Pulse measurement, Rating of per diode	Max.1.05	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =V <sub>RM</sub> , Pulse measurement, Rating of per diode	Max.10	μA
Thermal Resistance	θ <sub>ic</sub>	junction to case With heatsink	Max.1.9	°C/W
	θ <sub>il</sub>	junction to lead Without heatsink	Max.6	
	θ <sub>ia</sub>	junction to ambient Without heatsink	Max.26	

**D10XBxH**      Forward Voltage



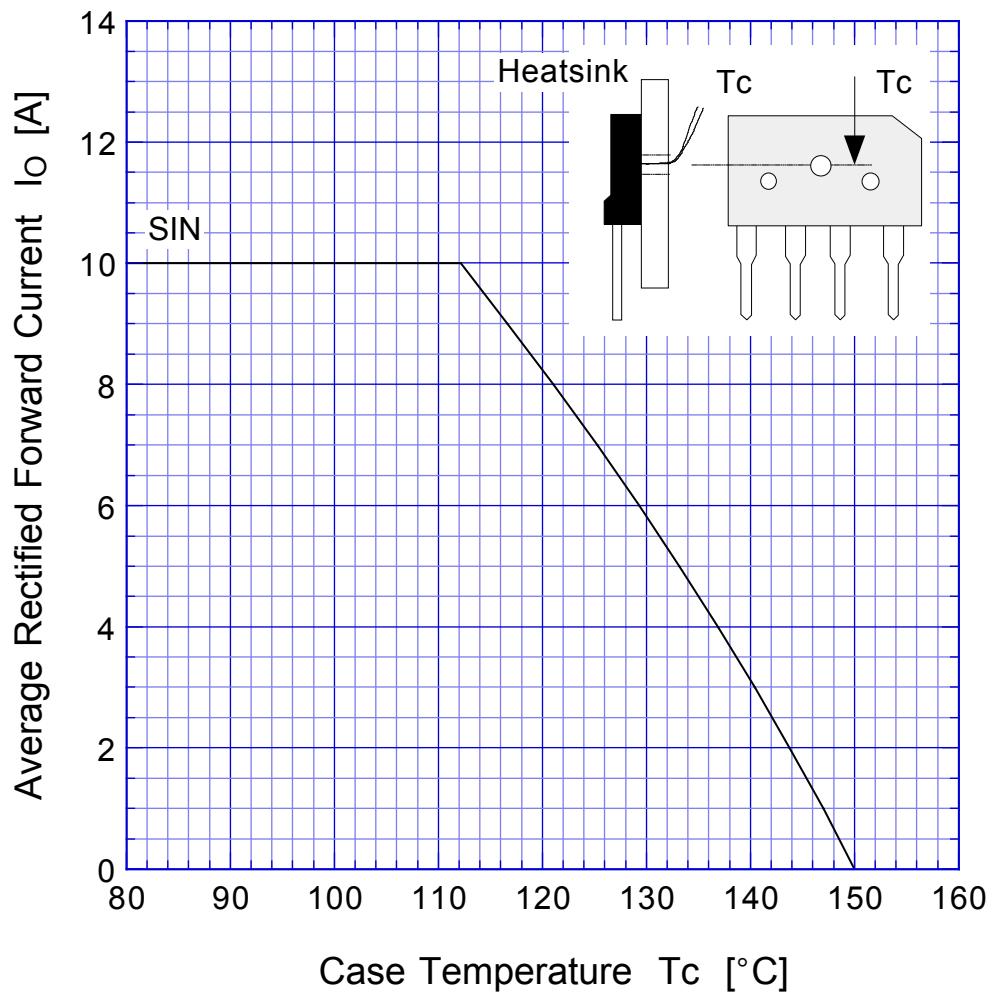
**D10XBxH      Forward Power Dissipation**



$T_j = 150^\circ\text{C}$   
Sine wave

# D10XBxH

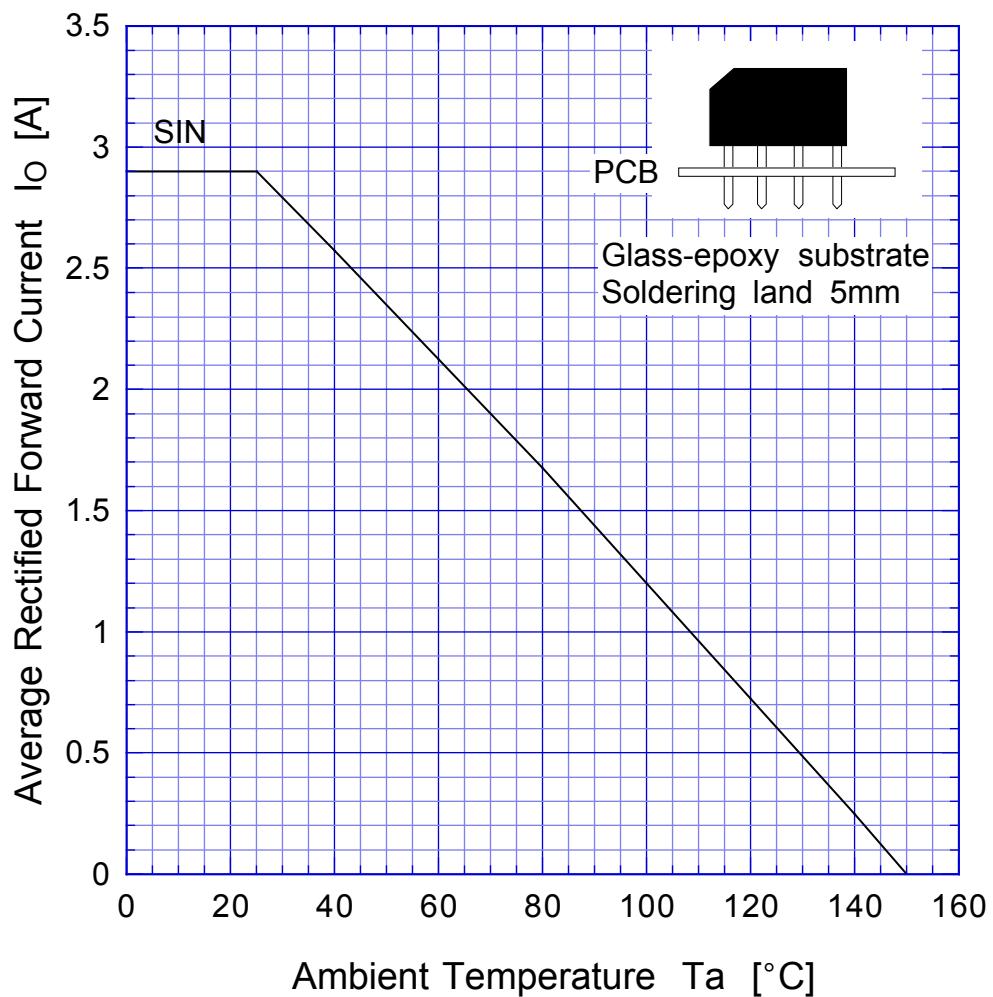
## Derating Curve



Sine wave  
R-load  
with heatsink

D10XBxH

Derating Curve



Sine wave  
R-load  
Free in air

## D10XBxH Peak Surge Forward Capability

